### 503799404 04/26/2016

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
DEYUAN ZHANG	04/21/2016
HONGTAO SUN	04/21/2016
LIPING CHEN	04/21/2016
HAIPING QI	04/21/2016
WENJIAO LIN	04/21/2016
LI QIN	04/21/2016

#### **RECEIVING PARTY DATA**

Name:	LIFETECH SCIENTIFIC (SHENZHEN) CO. LTD.
Street Address:	FLOOR 1-5, CYBIO ELECTRONIC BLDG., LANGSHAN 2ND ST.
Internal Address:	NORTH AREA OF HIGH TECH PARK, NANSHAN DISTRICT
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518000

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15032100

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	RAYMOND SUN
SIGNATURE:	/Raymond Sun/
DATE SIGNED:	04/26/2016

PATENT REEL: 038382 FRAME: 0215

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# **Total Attachments: 2** source=pat2106assign#page1.tif source=pat2106assign#page2.tif

PATENT REEL: 038382 FRAME: 0216

Docket No.: PAT-2106

## **ASSIGNMENT**

#### **INVENTORS:**

Deyuan Zhang, Hongtao Sun, Liping Chen Haiping Qi, Wenjiao Lin, Li Qin

In consideration of the sum of one U.S. dollar (US\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned agree to assign, and hereby does assign, transfer and set over to <u>Lifetech Scientific (Shenzhen) Co., Ltd.</u>, having an address of <u>Floor 1-5</u>, <u>Cybio Electronic Bldg.</u>, <u>Langshan 2nd St.</u>, <u>North Area of High Tech Park, Nanshan District, Shenzhen 518000, P. R. China</u> (hereinafter designated the "Assignee") the entire worldwide right, title and interest in the invention known as <u>Bioresorbable Iron-Based Alloy Stent</u>, as set forth and claimed in PCT Application No. <u>PCT/CN2014/090110</u>, filed October 31, 2014.

The undersigned agree to execute all papers necessary in connection with the application and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the international Convention for Protection of Industrial Property or similar agreements.

The undersigned agree to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize and request the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or continuing applications thereof to Assignee, as Assignee of the entire interest, and hereby covenant that they have full right to convey the entire interest herein assigned, and that they have not executed and will not execute any agreement in conflict herewith.

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The undersigned hereby grant RAYMOND SUN, Reg. No. 35,699, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent & Trademark Office for recordation of this document.

Dated: April 21, 2016	Signature: Deyuan Zhang
Dated: April 21, 2016	Signature: Hongton Sun Hongton Sun
Dated: April 21, 2016	Signature: Liping Chen Liping Chen
Dated: April 21, 2016	Signature: Haiping Qi
Dated: April 21, 2016	Signature: Wenjiao Lin Wenjiao Lin
Dated: April 21, 2016	Signature: Li Qin